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Dual N-Channel PowerTrench[®] MOSFET Q1: 30 V, 12 A, 12.0 m Ω Q2: 30 V, 22 A, 11.6 m Ω

Features

Q1: N-Channel

- Max $r_{DS(on)}$ = 12.0 m Ω at V_{GS} = 10 V, I_D = 11.5 A
- Max $r_{DS(on)}$ = 16.4 m Ω at V_{GS} = 4.5 V, I_D = 10 A

Q2: N-Channel

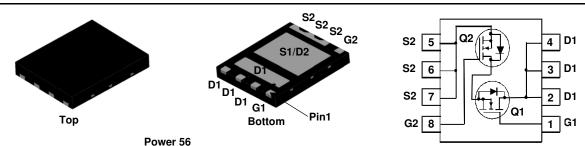
- Max $r_{DS(on)}$ = 11.6 m Ω at V_{GS} = 10 V, I_D = 12 A
- Max $r_{DS(on)}$ = 17.2 m Ω at V_{GS} = 4.5 V, I_D = 9.5 A
- RoHS Compliant

General Description

This device includes two specialized N-Channel MOSFETs in a dual MLP package. The switch node has been internally connected to enable easy placement and routing of synchronous buck converters. The control MOSFET (Q1) and synchronous MOSFET (Q2) have been designed to provide optimal power efficiency.

Applications

- Computing
- Communications
- General Purpose Point of Load
- Notebook Charger



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units	
V _{DS}	Drain to Source Voltage		30	30	V	
V _{GS}	Gate to Source Voltage	(Note 3)	±20	±20	V	
	Drain Current -Continuous	T _C = 25 °C	12	22	1	
I _D	-Continuous	T _A = 25 °C	11.5 ^{1a}	12 ^{1b}	Α	
	-Pulsed		50	60		
E _{AS}	Single Pulse Avalanche Energy	(Note 4)	25	33	mJ	
P _D	Power Dissipation for Single Operation	T _A = 25°C	2.2 ^{1a}	2.5 ^{1b}	W	
	Power Dissipation for Single Operation	T _A = 25°C	1.0 ^{1c}	1.0 ^{1d}	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to	+150	°C	

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	57 ^{1a}	50 ^{1b}	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	125 ^{1c}	120 ^{1d}	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	4.6	4.7	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7606	FDMS7606	Power 56	13 "	12 mm	3000 units

May 2014

FDMS7606 Dual
Dual N
V-Channel
PowerTrench [®]
MOSFET

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	Q1 Q2	30 30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, referenced to 25°C			16 20		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24$ V, $V_{GS} = 0$ V				1 1	μA
I _{GSS}	Gate to Source Leakage Curent	$V_{GS} = 20 V, V_{DS} = 0 V$ $V_{GS} = \pm 20 V, V_{DS} = 0 V$	Q1 Q2			100 ±100	nA
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$	Q1 Q2	1.0 1.0	2.1 1.9	3.0 3.0	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, referenced to 25°C	Q1 Q2		-6 -5.5		mV/°C
	Static Drain to Source On Resistance		Q1		9.2 12.6 11.8	12.0 16.4 14.7	.4 .7
r _{DS(on)}	Static Drain to Source On Resistance		Q2		9.7 12.8 12.3	11.6 17.2 15.4	mΩ
9 _{FS}	Forward Transconductance	$V_{DD} = 5 V, I_D = 11.5 A$ $V_{DD} = 5 V, I_D = 12 A$	Q1 Q2		53 47		S
Dynamic	Characteristics						
C _{iss}	Input Capacitance	Q1: V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHZ	Q1 Q2		1050 947	1400 1260	pF
C _{oss}	Output Capacitance	Q2:	Q1 Q2		295 191	395 255	pF
C _{rss}	Reverse Transfer Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHZ			32 131	50 200	pF
R _g	Gate Resistance		Q1 Q2	0.2 0.2	1.6 1.0	4.0 2.5	Ω
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time	Q1	Q1 Q2		7 6	14 12	ns
t _r	Rise Time	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 11.5 \text{ A}, \text{ R}_{\text{GEN}} = 6 \Omega$	Q1 Q2		3 3	10 10	ns
t _{d(off)}	Turn-Off Delay Time	Q2 V _{DD} = 15 V, I _D = 12 A, R _{GEN} = 6 Ω	Q1 Q2		18 19	33 34	ns
t _f	Fall Time		Q1 Q2		3 3	10 10	ns
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0V$ to 10 V Q1	Q1 Q2		16 19	22 27	nC
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0V \text{ to } 5 \text{ V}$ $I_D = 11.5 \text{ A}$	Q1 Q2		8 10	11 15	nC
	1	+		1		1	1

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

Gate to Source Charge

Gate to Drain "Miller" Charge

 Q_{gs}

 Q_{gd}

nC

nC

Q1

Q2

Q1

Q2

Q2 $V_{DD} = 15 V,$ $I_{D} = 12 A$ 3.2

2.6

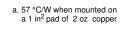
2.0

4.2

Symbol	Parameter	Test Conditions		Туре	Min	Тур	Max	Units		
Drain-Source Diode Characteristics										
V _{SD}	Source-Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 2 A	(Note 2)	Q1		0.76	1.2	V		
		V _{GS} = 0 V, I _S = 11.5 A	(Note 2)	Q1		0.87	1.2			
		$V_{GS} = 0 V, I_{S} = 2 A$	(Note 2)	Q2		0.75	1.2			
		$V_{GS} = 0 V, I_S = 12 A$	(Note 2)	Q2		0.85	1.2			
	David David Time	Q1		Q1		22	35			
t _{rr}	Reverse Recovery Time	$I_{\rm F} = 11.5$ A, di/dt = 100 A/s		Q2		18	33	ns		
Q _{rr} Rever	David David Olympic	Q2		Q1		7	13			
	Reverse Recovery Charge	I _F = 12 A, di/dt = 100 A/s		Q2		6	12	nC		

1.8_{0,JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{0,JC}$ is guaranteed by design while R_{0CA} is determined by the user's board design.







b. 50 °C/W when mounted on a 1 in² pad of 2 oz copper



c. 125 °C/W when mounted on a minimum pad of 2 oz copper



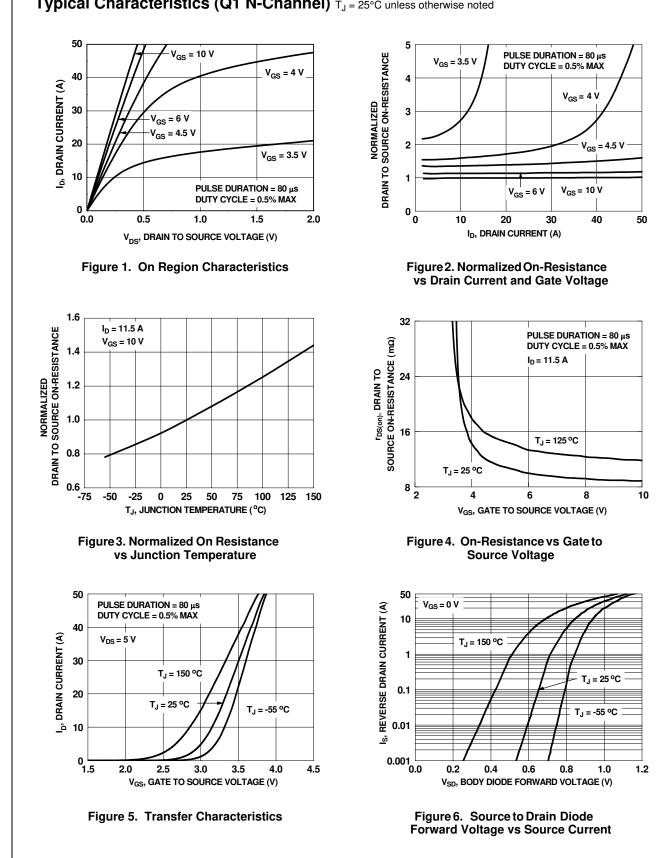
d. 120 °C/W when mounted on a minimum pad of 2 oz copper

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied

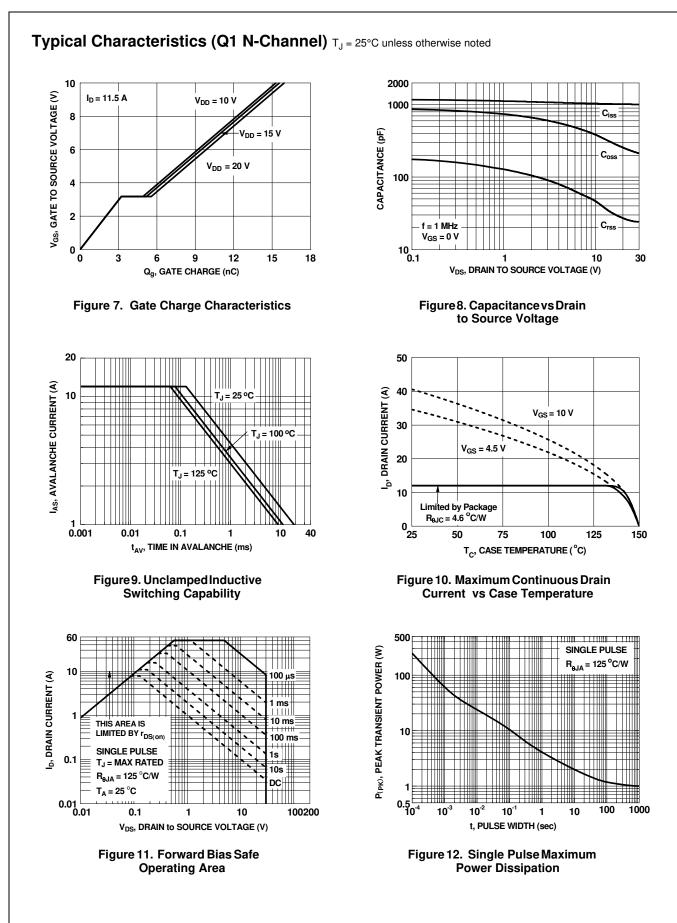
4. Q1: E_{AS} of 25 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 13 A, V_{DD} = 27 V, V_{GS} = 10 V.

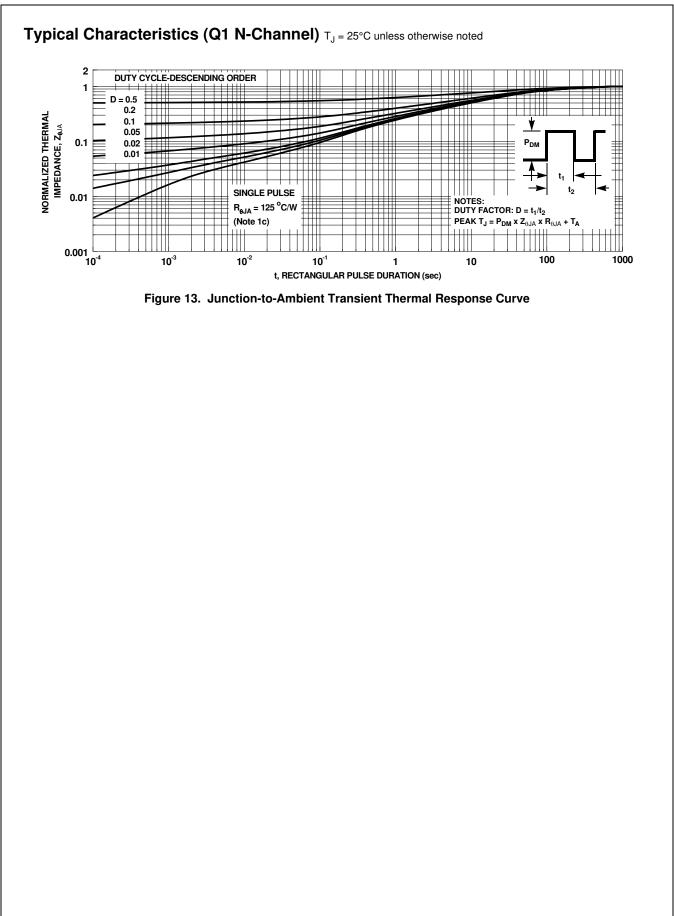
Q2: E_{AS} of 33 mJ is based on starting T_{J} = 25 °C, L = 0.3 mH, I_{AS} = 15 A, V_{DD} = 27 V, V_{GS} = 10 V.

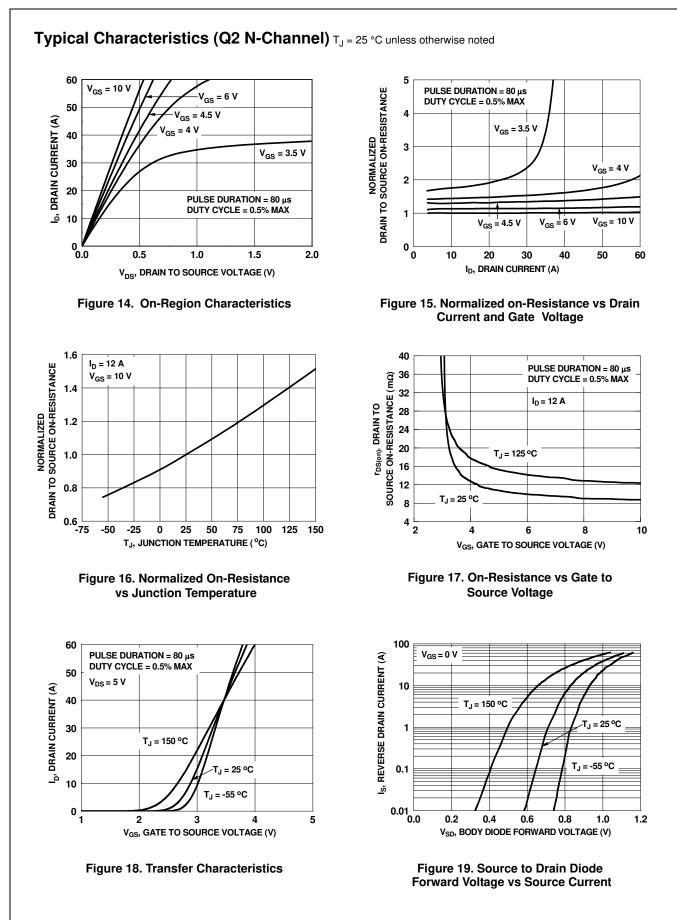


Typical Characteristics (Q1 N-Channel) T_J = 25°C unless otherwise noted

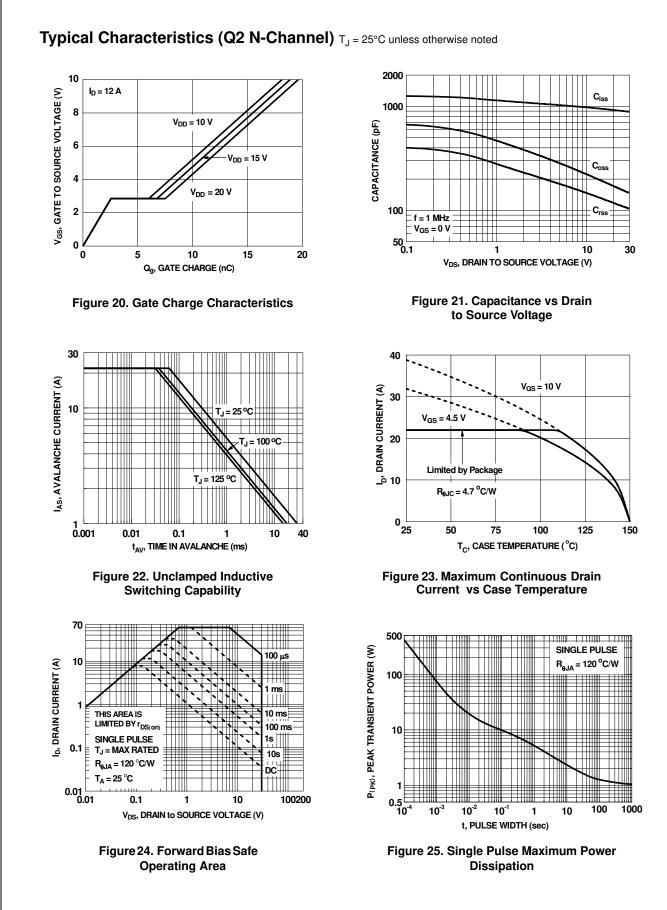




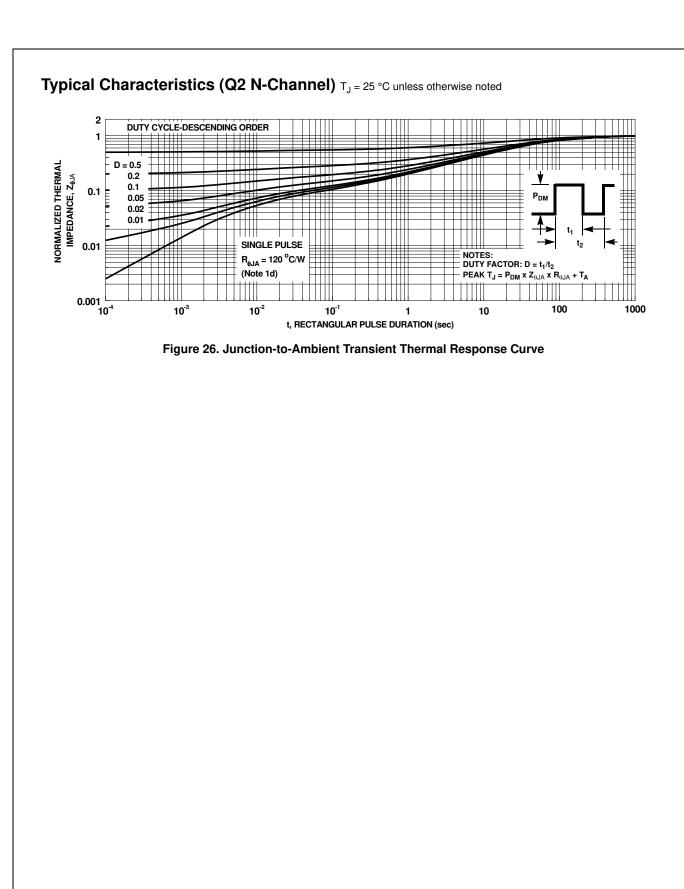












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